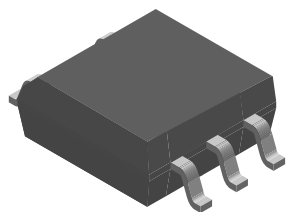
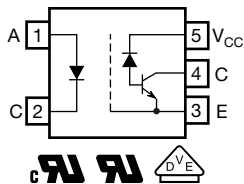


Analog High Speed Coupler, High Noise Immunity, 1 MBd, SOP-5 Package



20409-1


RoHS
COMPLIANT

FEATURES

- Surface mountable
- Industry standard SOP-5 footprint
- Compatible with infrared vapor phase reflow and wave soldering processes
- Isolation test voltage, 3750 V_{RMS}
- Very high common mode transient immunity: 15 000 V/μs at V_{CM} = 1500 V guaranteed
- High speed: 1 MBd
- TTL compatible
- Open collector output
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

LINKS TO ADDITIONAL RESOURCES



DESCRIPTION

The VOM453 high speed optocoupler consists of a GaAlAs infrared emitting diode, optically coupled with an integrated photo detector and a high speed transistor. The photo detector is junction isolated from the transistor to reduce miller capacitance effects. The open collector output function allows circuit designers to adjust the load conditions when interfacing with different logic systems such as TTL, CMOS, etc.

Because the VOM453 has a Faraday shield on the detector chip, it can also reject and minimize high input to output common mode transient voltages. There is no base connection, further reducing the potential electrical noise entering the package.

The VOM453 is packaged in a industry standard SOP-5 package and is suitable for surface mounting.

This an ideal solution for industrial communication bus isolation, as well as isolated drive circuit applications such as IPM (intelligent power module) drivers.

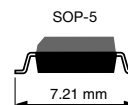
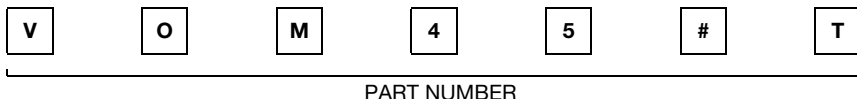
APPLICATIONS

- Fieldbus communication and control
- Logic ground isolation
- Analog signal ground isolation
- Replace pulse transformers
- IPM (intelligent power module) drivers

AGENCY APPROVALS

- [UL](#)
- [cUL](#)
- [DIN EN 60747-5-5 \(VDE 0884-5\)](#), available with option 1

ORDERING INFORMATION



AGENCY CERTIFIED/PACKAGE	CMTI (kV/μs)
UL, cUL	≥ 15
SOP-5	VOM453T

Notes

- For additional information on the available options refer to option information
- The product is available only on tape and reel



ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
INPUT				
Reverse voltage		V_R	3	V
DC forward current		I_F	25	mA
Surge forward current	$t_p \leq 1\text{ }\mu\text{s}$, 300 pulses/s	I_{FSM}	1	A
Power dissipation	$T_{amb} \leq 70\text{ }^{\circ}\text{C}$	P_{diss}	45	mW
OUTPUT				
Supply voltage		V_S	-0.5 to +30	V
Output voltage		V_O	-0.5 to +25	V
Output current		I_O	8	mA
Power dissipation	$T_{amb} \leq 70\text{ }^{\circ}\text{C}$	P_{diss}	100	mW
COUPLER				
Storage temperature range		T_{stg}	-55 to +125	$^{\circ}\text{C}$
Ambient temperature range		T_{amb}	-55 to +100	$^{\circ}\text{C}$
Junction temperature		T_j	100	$^{\circ}\text{C}$
Soldering temperature	$t < 10\text{ s max.}$		260	$^{\circ}\text{C}$

Note

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

ELECTRICAL CHARACTERISTICS ($T_{amb} = -40\text{ }^{\circ}\text{C}$ to $+100\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT						
Input forward voltage	$I_F = 16\text{ mA}$	V_F	-	1.4	1.8	V
Input reverse current	$V_R = 3\text{ V}$	I_R	-	0.5	10	μA
Input capacitance	$f = 1\text{ MHz}$, $V_F = 0\text{ V}$, $T_{amb} = 25\text{ }^{\circ}\text{C}$	C_{IN}	-	75	-	pF
Temperature coefficient of forward voltage	$I_F = 16\text{ mA}$	$\Delta V_F / \Delta T_{amb}$	-	-1.7	-	mV/ $^{\circ}\text{C}$
OUTPUT						
Logic low supply current	$I_F = 16\text{ mA}$, $V_O = \text{open}$, $V_{CC} = 15\text{ V}$	I_{CCL}	-	200	-	μA
Logic high supply current	$I_F = 0\text{ mA}$, $V_O = \text{open}$, $V_{CC} = 15\text{ V}$, $T_{amb} = 25\text{ }^{\circ}\text{C}$	I_{CCH}	-	0.001	1	μA
	$I_F = 0\text{ mA}$, $V_O = \text{open}$, $V_{CC} = 15\text{ V}$	I_{CCH}	-	-	2	μA
Logic low output voltage	$I_F = 16\text{ mA}$, $V_{CC} = 4.5\text{ V}$, $I_O = 3\text{ mA}$, $T_{amb} = 25\text{ }^{\circ}\text{C}$	V_{OL}	-	0.15	0.4	V
	$I_F = 16\text{ mA}$, $V_{CC} = 15\text{ V}$, $I_O = 2.4\text{ mA}$	V_{OL}	-	-	0.5	V
Logic high output current	$I_F = 0\text{ mA}$, $V_O = V_{CC} = 5.5\text{ V}$, $T_{amb} = 25\text{ }^{\circ}\text{C}$	I_{OH}	-	0.003	0.5	μA
	$I_F = 0\text{ mA}$, $V_O = V_{CC} = 15\text{ V}$, $T_{amb} = 25\text{ }^{\circ}\text{C}$	I_{OH}	-	0.01	1	μA
	$I_F = 0\text{ mA}$, $V_O = V_{CC} = 15\text{ V}$	I_{OH}	-	-	50	μA
COUPLER						
Capacitance (input-output) ⁽¹⁾	$f = 1\text{ MHz}$, $T_{amb} = 25\text{ }^{\circ}\text{C}$	C_{IO}	-	0.4	-	pF

Notes

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements. All typical values are measured at $T_{amb} = 25\text{ }^{\circ}\text{C}$.
- A 0.1 μF bypass capacitor connected between pins 4 and 6 is recommended.

CURRENT TRANSFER RATIO ($T_{amb} = -40\text{ }^{\circ}\text{C}$ to $+100\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Current transfer ratio ⁽¹⁾⁽²⁾	$V_O = 0.5\text{ V}$, $I_F = 16\text{ mA}$, $V_{CC} = 4.5\text{ V}$	CTR	15	30	-	%
	$V_O = 0.4\text{ V}$, $I_F = 16\text{ mA}$, $T_{amb} = 25\text{ }^{\circ}\text{C}$		20	-	50	

Notes

- Current transfer ratio in percent equals the ratio of output collector current (I_O) to the forward LED input current (I_F) times 100.
- A 0.1 μF bypass capacitor connected between pins 4 and 6 is recommended. All typical values are measured at $T_{amb} = 25\text{ }^{\circ}\text{C}$.

SWITCHING CHARACTERISTICS ($T_{amb} = -40\text{ }^{\circ}\text{C}$ to $+100\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Propagation delay time to logic low at output (see Fig. 1 and note 1)	$V_{CC} = 5\text{ V}$, $I_F = 16\text{ mA}$, $R_L = 1.9\text{ k}\Omega$	t_{PHL}	-	0.2	1	μs
Propagation delay time to logic high at output (see Fig. 1 and note 1)	$V_{CC} = 5\text{ V}$, $I_F = 16\text{ mA}$, $R_L = 1.9\text{ k}\Omega$	t_{PLH}	-	0.5	1	μs

Note

(1) The $1.9\text{ k}\Omega$ load represents 1 TTL unit load of 1.6 mA and the $5.6\text{ k}\Omega$ pull-up resistor. All typical values are measured at $T_{amb} = 25\text{ }^{\circ}\text{C}$.

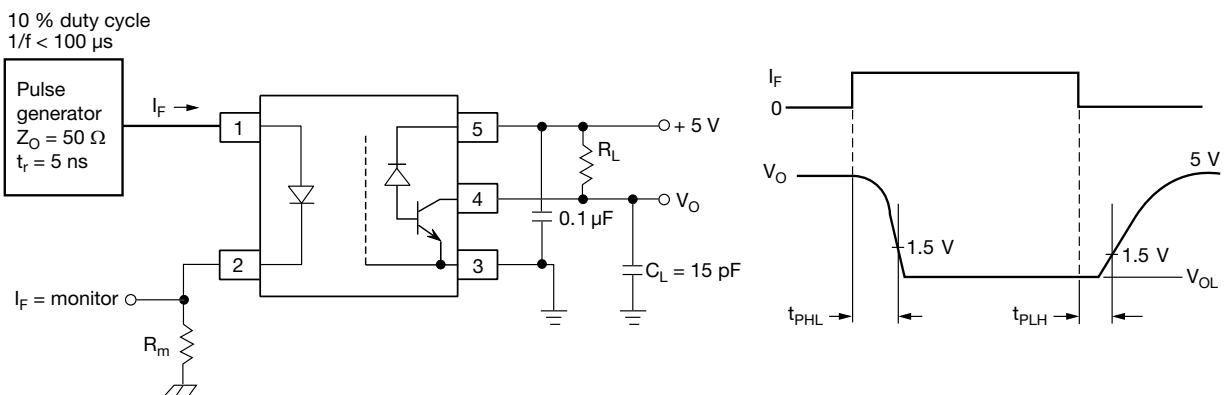


Fig. 1 - Test Circuit for Switching Times

COMMON MODE TRANSIENT IMMUNITY ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Common mode transient immunity at logic high level output (see Fig. 2 and notes 1, and 2)	$R_L = 1.9\text{ k}\Omega$, $I_F = 0\text{ mA}$, $V_{CM} = 1500\text{ V}_{P-P}$	$ CM_H $	15 000	-	-	$\text{V}/\mu\text{s}$
Common mode transient immunity at logic low level output (see Fig. 2 and notes 1, and 2)	$R_L = 1.9\text{ k}\Omega$, $I_F = 16\text{ mA}$, $V_{CM} = 1500\text{ V}_{P-P}$	$ CM_L $	15 000	-	-	$\text{V}/\mu\text{s}$

Notes

- (1) Common mode transient immunity in a logic high level is the maximum tolerable (positive) dV_{CM}/dt on the leading edge of the common mode pulse (V_{CM}) to assure that the output will remain in a logic high state (i.e., $V_O > 2\text{ V}$). Common mode transient immunity in a logic low level is the maximum tolerable (negative) dV_{CM}/dt on the trailing edge of the common mode pulse signal (V_{CM}) to assure that the output will remain in logic low state, i.e., $V_O > 0.8\text{ V}$.
- (2) The $1.9\text{ k}\Omega$ load represents 1 TTL unit load of 1.6 mA and the $5.6\text{ k}\Omega$ pull-up resistor.

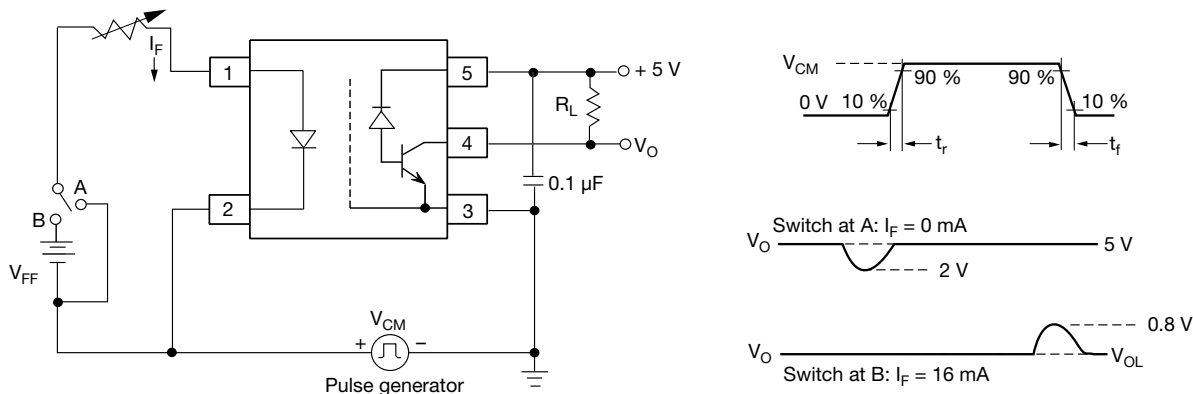


Fig. 2 - Test Circuit for Transient Immunity and Typical Waveforms

SAFETY AND INSULATION RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Climatic classification	According to IEC 68 part 1		55 / 100 / 21	
Pollution degree	According to DIN VDE 0109		2	
Comparative tracking index	Insulation group IIIa	CTI	175	
Maximum rated withstanding isolation voltage	According to UL1577, $t = 1\text{ min}$	V_{ISO}	3750	V_{RMS}
Maximum transient isolation voltage	According to DIN EN 60747-5-5	V_{IOTM}	6000	V_{peak}
Maximum repetitive peak isolation voltage	According to DIN EN 60747-5-5	V_{IORM}	707	V_{peak}
Isolation resistance	$T_{amb} = 25\text{ }^{\circ}\text{C}$, $V_{IO} = 500\text{ V}$	R_{IO}	$\geq 10^{12}$	Ω
	$T_{amb} = 100\text{ }^{\circ}\text{C}$, $V_{IO} = 500\text{ V}$	R_{IO}	$\geq 10^{11}$	Ω
Output safety power		P_{SO}	350	mW
Input safety current		I_{SI}	150	mA
Input safety temperature		T_S	175	$^{\circ}\text{C}$
Creepage distance			≥ 5	mm
Clearance distance			≥ 5	mm
Insulation thickness		DTI	≥ 0.1	mm
Input to output test voltage, method B	$V_{IORM} \times 1.875 = V_{PR}$, 100 % production test with $t_M = 1\text{ s}$, partial discharge $< 5\text{ pC}$	V_{PR}	1669	V_{peak}

Note

- As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for “safe electrical insulation” only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits.

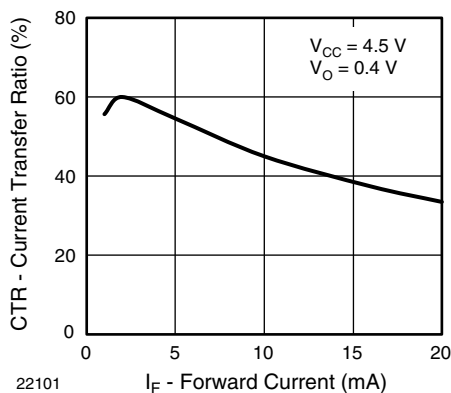
TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)


Fig. 3 - Current Transfer Ratio vs. Forward Current

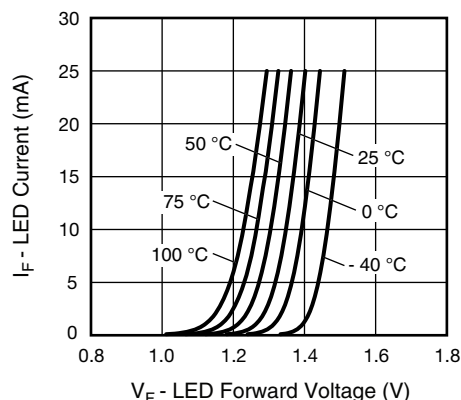


Fig. 4 - LED Current vs. LED Forward Voltage

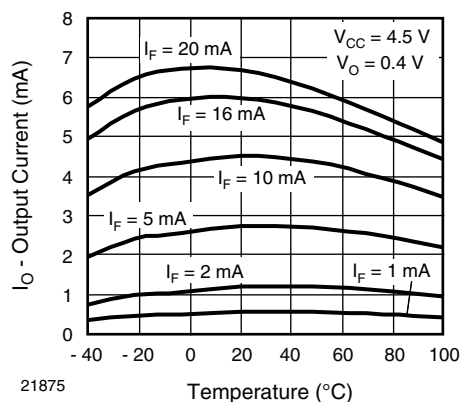


Fig. 5 - Output Current vs. Temperature

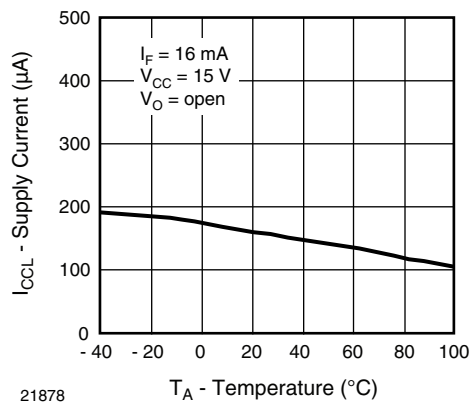


Fig. 8 - Supply Current vs. Temperature

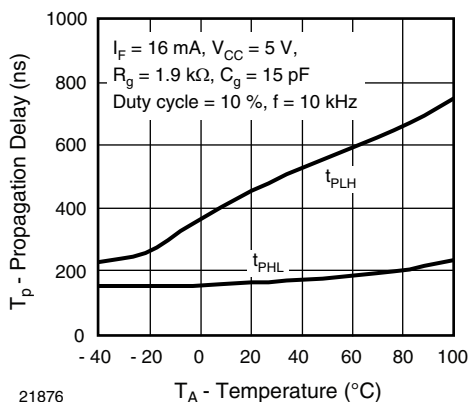


Fig. 6 - Propagation Delay vs. Temperature

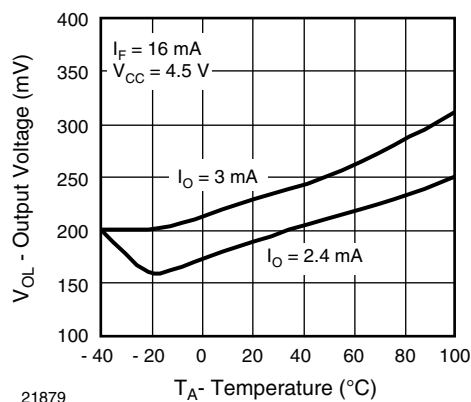


Fig. 9 - Logic Low Output Voltage vs. Temperature

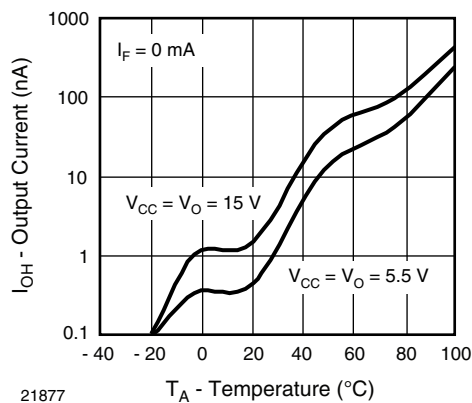


Fig. 7 - Logic High Output Current vs. Temperature

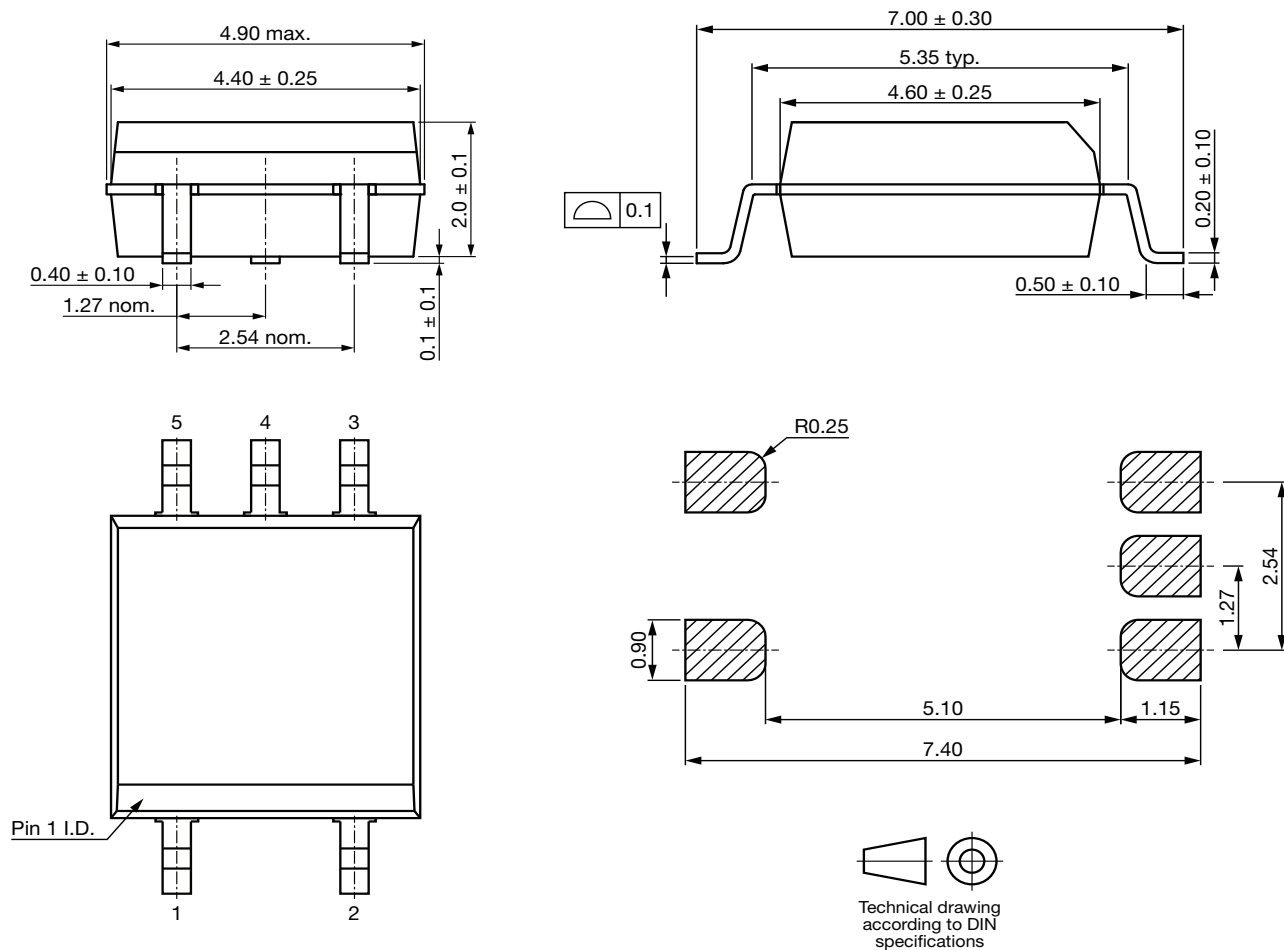
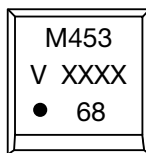
PACKAGE DIMENSIONS (in millimeters)

PACKAGE MARKING


Fig. 10 - Example of VOM453T

Notes

- XXXX = LMC (lot marking code)
- VDE logo is not part of the package marking
- Tape and reel suffix (T) is not part of the package marking

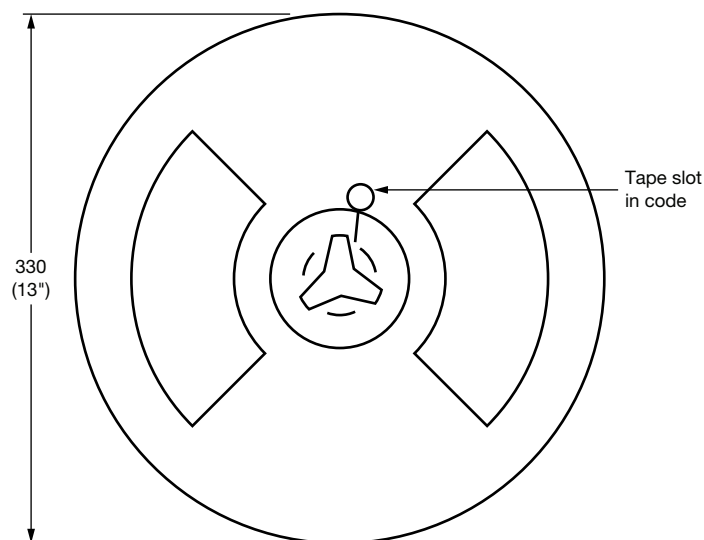
PACKING INFORMATION (tape and reel)


Fig. 11 - Tape and Reel Shipping Medium

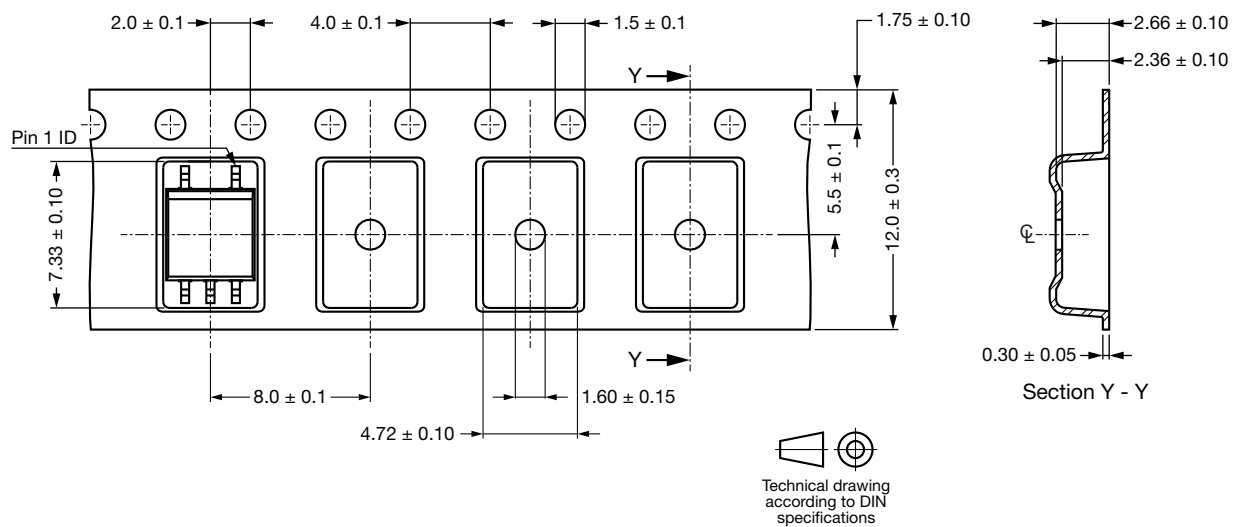
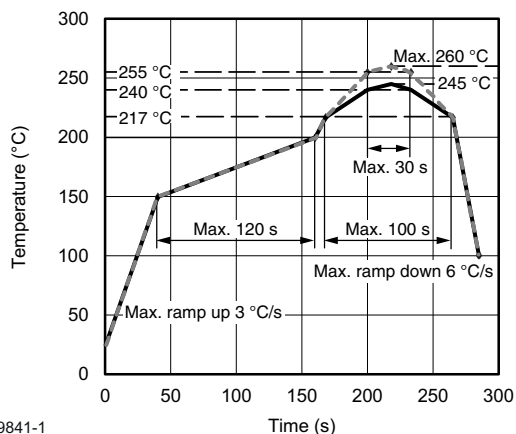


Fig. 12 - Tape and Reel Packing (2000 pieces on reel)



SOLDER PROFILE



19841-1

Fig. 13 - Lead (Pb)-free Reflow Solder Profile
According to J-STD-020

HANDLING AND STORAGE CONDITIONS

ESD level: HBM class 2

Floor life: unlimited

Conditions: $T_{amb} < 30\text{ °C}$, RH < 85 %

Moisture sensitivity level 1, according to J-STD-020



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